

RENESAS SEMICONDUCTOR RELIABILITY REPORT

SERIES: UPC811G2

DEVICE: UPC811G2-A
UPC811G2-E1-A
UPC811G2-E2-A
UPC811G2-AP
UPC811G2-E1-AP
UPC811G2-E2-AP

For both products manufactured by Naito Densetsu Sado Factory (NDK) and UTAC THAI Limited (UTL)

APPLICATION: Standard

Quality Assurance Div.
Renesas Electronics Corporation

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Reliability test result

Test Items	Reference	Test Conditions	Results Reject/Size
High Temperature Operating Life	JESD22-A108	Ta=125 °C, Apply rated voltage, 1,000h	0/22
Temperature Humidity Bias (HAST)	JESD22-A110	Ta=85 °C, 85%RH, Apply rated voltage, 1,000h	0/22
Temperature Cycling	JESD22-A104	Ta=-65 ~ 150 °C, 200 cycles	0/22
High Temperature Storage Life	JESD22-A103	Ta=150 °C, 1,000h	0/22
Resistance to Soldering Heat	JESD22-A113, J-STD-020	Bake: 125°C, 24h Moisture Soak: 85°C85%RH, 168h (MSL=1) Reflow: 260°Cmax, 255°Cx30s, 3 times	0/22
Solderability	J-STD-002	245°C, 5s (Solder wetting area 95% or more)	0/22
Electrostatic discharge (HBM Method)	JS-001	C=100pF, R=1.5k ohm, ±1,000V	0/3
Electrostatic discharge (CDM Method)	JESD22-C101	±500V	0/3
Estimated Failure Rate	-	Estimated failure rate: 15Fit Ta= 55°C, Ea=0.7eV, C.L.=60%	

Reliability test results may include data from family representative products.

MSL Preconditioning was performed prior to Temperature Humidity Bias and Temperature Cycling.

<Judgement criteria>

Electrical characteristics described in the delivery specification.

(Solderability test is excluded.)

<Preconditioning Details>

125°C, 24h + 85°C85%RH 168h (JEDEC MSL1) -> Reflow (260°Cmax, 255°Cx30s, 3 times)